

| Name | Employer | Affiliation | Mon | Tue | Wed | Thu | Credit |
|----------------------------|--------------------------------|--------------------------------|-----|-----|-----|-----|--------|
| Abbas, Ghani | Ericsson AB | Ericsson AB | 1 | 1 | 1 | 1 | 4 |
| Abbott, John | Corning Incorporated | Corning Incorporated | 1 | 1 | 1 | 0 | 3 |
| Abramson, David | Texas Instruments Incorporated | Texas Instruments Incorporated | 1 | 1 | 0 | 1 | 3 |
| Abughazaleh, Shadi | | Hubbell Incorporated | 1 | 1 | 1 | 1 | 4 |
| Agata, Akira | KDDI R&D Laboratories | KDDI R&D Laboratories | 1 | 1 | 1 | 1 | 4 |
| Allard, Michel | Cogeco Cable | Cogeco Cable | 1 | 1 | 1 | 1 | 4 |
| Anderson, Jon | Oclaro, Inc. | Oclaro, Inc. | 1 | 1 | 1 | 1 | 4 |
| Anglade, Ony | Cox Communications Inc. | Cox Communications Inc. | 1 | 1 | 1 | 1 | 4 |
| Anslow, Peter | Ciena Corporation | Ciena Corporation | 1 | 1 | 1 | 1 | 4 |
| Aoshima, Kenji | | Hitachi Cable,Ltd | 0 | 1 | 0 | 0 | 1 |
| Arunarathi, Venkat | Cortina Systems | Cortina Systems | 0 | 1 | 1 | 1 | 3 |
| Babenko, Oleksandr | | Molex Incorporated | 1 | 1 | 1 | 1 | 4 |
| Balasubramanian, Koussalya | Cisco Systems, Inc. | Cisco Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Baldwin, Thananya | | Ixia | 1 | 1 | 1 | 0 | 3 |
| Barr, David | Entropic Communications | Entropic Communications | 0 | 1 | 1 | 1 | 3 |
| Barrass, Hugh | Cisco Systems, Inc. | Cisco Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Bates, Stephen | PMC-Sierra, Inc. | PMC-Sierra, Inc. | 1 | 1 | 1 | 1 | 4 |
| Beaudoin, Denis | Texas Instruments Incorporated | Texas Instruments Incorporated | 1 | 1 | 1 | 1 | 4 |
| Beia, Christian | STMicroelectronics | STMicroelectronics | 0 | 1 | 1 | 1 | 3 |
| Bennett, Michael | Lawrence Berkeley National Lab | Lawrence Berkeley National Lab | 0 | 1 | 1 | 1 | 3 |
| Berry, Joe | | Bel Fuse | 0 | 1 | 1 | 0 | 2 |
| Bhatt, Vipul | Cisco Systems, Inc. | Cisco Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Bist, Hemlata | | Cadence Design Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Bliss, William | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Booth, Brad | Dell | Dell | 0 | 1 | 0 | 1 | 2 |
| Boyd, Edward | | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Braun, Ralf-Peter | Deutsche Telekom AG | Deutsche Telekom AG | 1 | 1 | 1 | 1 | 4 |
| Brophy, Timothy | Cisco Systems, Inc. | Cisco Systems, Inc. | 0 | 0 | 1 | 1 | 2 |

| Name | Employer | Affiliation | Mon | Tue | Wed | Thu | Credit |
|-------------------|-----------------------------------|-----------------------------------|-----|-----|-----|-----|--------|
| Brown, Alan | Aurora Networks, Inc. | Aurora Networks, Inc. | 1 | 1 | 1 | 1 | 4 |
| Brown, David | | Semtech Ltd | 0 | 1 | 1 | 1 | 3 |
| Brown, Matthew | Applied Micro (AMCC) | Applied Micro (AMCC) | 1 | 1 | 1 | 1 | 4 |
| Brownlee, Phillip | Coilcraft, Inc. | Coilcraft, Inc. | 0 | 0 | 1 | 0 | 1 |
| Bugg, Mark | | Molex Incorporated | 1 | 1 | 1 | 1 | 4 |
| Burt, Kevin | | Samtec, Inc. | 0 | 1 | 1 | 0 | 2 |
| Carlson, Steve | High-Speed Design Inc. | High-Speed Design Inc. | 1 | 1 | 1 | 1 | 4 |
| Casher, Patrick | | Molex Incorporated | 1 | 1 | 1 | 1 | 4 |
| Chadha, Mandeep | Vitesse Semiconductor Corporation | Vitesse Semiconductor Corporation | 1 | 1 | 1 | 0 | 3 |
| Chalupsky, David | Intel Corporation | Intel Corporation | 1 | 1 | 1 | 1 | 4 |
| Chang, Jacky | Hewlett-Packard Development | Hewlett-Packard Development | 1 | 1 | 1 | 1 | 4 |
| Chang, Xin | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Cibula, Peter | Intel Corporation | Intel Corporation | 1 | 1 | 1 | 1 | 4 |
| Conroy, Keith | | multiply | 0 | 0 | 0 | 1 | 1 |
| Cooper, William | RETIRED | NO AFFILIATION | 0 | 1 | 1 | 1 | 3 |
| Cornejo, Edward | | INDEPENDENT | 1 | 1 | 1 | 0 | 3 |
| Crepin, J. | | Akros Silicon Inc. | 1 | 1 | 1 | 1 | 4 |
| Cui, Kai | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 0 | 3 |
| Dai, Shaoan | Marvell Semiconductor, Inc. | Marvell Semiconductor, Inc. | 1 | 1 | 1 | 1 | 4 |
| Dalmia, Kamal | | Aquantia | 0 | 1 | 1 | 0 | 2 |
| Dambrosia, John | Dell | Dell | 1 | 1 | 1 | 1 | 4 |
| Darshan, Yair | Microsemi Corporation | Microsemi Corporation | 1 | 1 | 1 | 1 | 4 |
| Dawe, Piers | IPtronics | IPtronics | 0 | 1 | 1 | 1 | 3 |
| Delveaux, William | Cisco Systems, Inc. | Cisco Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Diab, Wael | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 1 | 1 | 4 |
| Dickinson, John | | Bright House Networks | 0 | 0 | 1 | 1 | 2 |
| Diminico, Chris | M C Communications, LLC | leoni | 1 | 1 | 1 | 1 | 4 |
| Donahue, Curtis | | UNH-IOL | 1 | 1 | 1 | 1 | 4 |

| Name | Employer | Affiliation | Mon | Tue | Wed | Thu | Credit |
|-----------------------|-----------------------------|------------------------------------|-----|-----|-----|-----|--------|
| Dove, Dan | Applied Micro (AMCC) | Applied Micro (AMCC) | 1 | 1 | 1 | 1 | 4 |
| Dudek, Mike | QLogic Corporation | QLogic Corporation | 1 | 1 | 1 | 1 | 4 |
| Dwelley, David | Linear Technology | Linear Technology | 1 | 1 | 1 | 1 | 4 |
| Eiriksson, Asgeir | Chelsio Communications | Chelsio Communications | 0 | 1 | 1 | 1 | 3 |
| Elbakoury, Hesham | Nortel Networks | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Erba, Simone | STMicroelectronics | STMicroelectronics | 0 | 1 | 1 | 1 | 3 |
| Estes, David | | UNH-IOL | 1 | 1 | 1 | 1 | 4 |
| Ewen, John | JDS Uniphase Corporation | IBM | 1 | 1 | 1 | 1 | 4 |
| Farhoodfar, Arash | Cortina Systems | Cortina Systems | 0 | 1 | 1 | 1 | 3 |
| Flatman, Alan | | LAN Technologies Corporation, Inc. | 1 | 1 | 1 | 1 | 4 |
| Folkens, Norbert | JDS Uniphase Corporation | JDS Uniphase Corporation | 1 | 1 | 1 | 0 | 3 |
| Forbes, Harry | Nexans Canada Inc. | Nexans Canada Inc. | 1 | 1 | 1 | 1 | 4 |
| Frazier, Howard | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 1 | 1 | 4 |
| Frosch, Richard | Phihong USA Inc, | Phihong USA Inc, | 0 | 1 | 1 | 1 | 3 |
| Garavaglia, Andrea | | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Gardner, Mike | | Molex Incorporated | 1 | 1 | 1 | 1 | 4 |
| Green, Malcolm | | Binoptics corp | 1 | 1 | 1 | 1 | 4 |
| Grimwood, Michael | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Grow, Robert | INDEPENDENT | RMG Consulting | 1 | 1 | 0 | 1 | 3 |
| Gundubogula, Sudhakar | Marvell Semiconductor, Inc. | Marvell Semiconductor, Inc. | 0 | 1 | 1 | 1 | 3 |
| Gustlin, Mark | Xilinx | Xilinx | 0 | 1 | 1 | 1 | 3 |
| Hajduczenia, Marek | ZTE Corporation | ZTE Corporation | 1 | 1 | 1 | 1 | 4 |
| Hammond, Bernie | ADC Telecommunications | TE Connectivity | 0 | 1 | 1 | 1 | 3 |
| HANNA, Charaf | STMicroelectronics | STMicroelectronics | 1 | 1 | 1 | 0 | 3 |
| Healey, Adam | LSI Corporation | LSI Corporation | 1 | 1 | 1 | 1 | 4 |
| Heath, Jeffrey | Linear Technology | Linear Technology | 0 | 1 | 1 | 1 | 3 |
| Herman, Carl | CommScope, Inc. | CommScope, Inc. | 1 | 1 | 1 | 1 | 4 |
| Hess, David | | CORD DATA | 1 | 1 | 1 | 0 | 3 |

| Name | Employer | Affiliation | Mon | Tue | Wed | Thu | Credit |
|-------------------|---------------------------------------|---------------------------------------|-----|-----|-----|-----|--------|
| Hidaka, Yasuo | Fujitsu Laboratories of America, Inc. | Fujitsu Laboratories of America, Inc. | 1 | 1 | 1 | 1 | 4 |
| Hou, Victor | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 1 | 0 | 3 |
| Huang, Xi | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Huang, Yin | | Qualcomm Incorporated | 1 | 1 | 1 | 1 | 4 |
| Irwin, Scott | MoSys, Inc. | MoSys, Inc. | 0 | 1 | 1 | 0 | 2 |
| Isono, Hideki | FUJITSU | Fujitsu Optical Components Limited | 1 | 1 | 1 | 0 | 3 |
| Iwaoka, Mitsuru | Yokogawa Electric Corporation | Yokogawa Electric Corporation | 0 | 0 | 0 | 1 | 1 |
| Jewell, Jack | Individual | INDEPENDENT | 1 | 1 | 1 | 1 | 4 |
| Jimenez, Andrew | Anixter Inc. | Anixter Inc. | 1 | 1 | 1 | 1 | 4 |
| Jones, Chad | Cisco Systems, Inc. | Cisco Systems, Inc. | 1 | 1 | 1 | 1 | 4 |
| Jones, Doug | | Comcast | 0 | 0 | 1 | 1 | 2 |
| Kasturia, Sanjay | Teranetics Inc | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Kawatsu, Yasuaki | Hitachi, Ltd. | Hitachi Cable Ltd | 1 | 1 | 1 | 0 | 3 |
| Keasler, William | Ikanos Communications, Inc. | Ikanos Communications, Inc. | 0 | 1 | 1 | 1 | 3 |
| Keeley, James | LSI | LSI Corporation | 1 | 1 | 1 | 1 | 4 |
| Kelsen, Michael | Time Warner Cable Inc. | Time Warner Cable Inc. | 1 | 1 | 1 | 1 | 4 |
| Kim, Yong | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 1 | 1 | 4 |
| King, Jonathan | Finisar Corporation | Finisar Corporation | 0 | 1 | 1 | 1 | 3 |
| Kish, Paul | | Belden | 1 | 1 | 1 | 1 | 4 |
| Kliger, Avi | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Knittle, Curtis | Cable Television Laboratories Inc. | Cable Television Laboratories Inc. | 0 | 1 | 1 | 1 | 3 |
| Ko, Dylan | Qualcomm Incorporated | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Kolesar, Paul | CommScope, Inc. | CommScope, Inc. | 0 | 1 | 1 | 0 | 2 |
| Kolze, Tom | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 0 | 1 | 3 |
| Kosanovich, Keith | | Leviton Manufacturing Co. | 0 | 0 | 1 | 1 | 2 |
| Kumar, C | sigrity inc | Cadence Design Systems, Inc. | 0 | 1 | 1 | 1 | 3 |
| Kvist, Bengt | Ericsson AB | Ericsson AB | 1 | 1 | 1 | 1 | 4 |
| Lackner, Hans | QoSCom GmbH | QoSCom - Quality in Communications | 1 | 1 | 1 | 1 | 4 |

| Name | Employer | Affiliation | Mon | Tue | Wed | Thu | Credit |
|----------------------|--------------------------|---------------------------------|-----|-----|-----|-----|--------|
| Larsen, Wayne | CommScope, Inc. | CommScope, Inc. | 1 | 1 | 1 | 1 | 4 |
| Laubach, Mark | Broadcom Corporation | Broadcom Corporation | 1 | 1 | 1 | 1 | 4 |
| Law, David | Hewlett-Packard Ltd | Hewlett-Packard Ltd | 1 | 1 | 1 | 1 | 4 |
| Lessard, Andre | CommScope, Inc. | CommScope, Inc. | 0 | 1 | 1 | 0 | 2 |
| Lewis, David | JDS Uniphase Corporation | JDS Uniphase Corporation | 0 | 1 | 1 | 1 | 3 |
| Li, Bo | | Huawei Technologies Co. Ltd | 0 | 1 | 1 | 0 | 2 |
| Li, Mike Peng | Altera Corporation | Altera Corporation | 1 | 1 | 1 | 0 | 3 |
| Li, Shaohua | | Brocade Communications Systems, | 0 | 1 | 1 | 1 | 3 |
| Li, Wen | Finisar Corporation | Finisar Corporation | 0 | 1 | 0 | 0 | 1 |
| Lindsay, Thomas | | ClariPhy Communications, Inc. | 0 | 1 | 1 | 1 | 3 |
| Liu, Zhenyu | | Marvell Semiconductor, Inc. | 0 | 1 | 1 | 1 | 3 |
| Lounsbury, Robert | | Rockwell Automation | 0 | 1 | 0 | 0 | 1 |
| Maguire, Valerie | The Siemon Company | The Siemon Company | 1 | 1 | 1 | 1 | 4 |
| MALKIMAN, YONATAN | Mellanox Technologies | Mellanox Technologies | 0 | 1 | 1 | 1 | 3 |
| Mallette, Edwin | Bright House Networks | Bright House Networks | 1 | 1 | 1 | 1 | 4 |
| Matheus, Kirsten | BMW Group | BMW Group | 0 | 1 | 1 | 1 | 3 |
| Maynes, Curt | | 3M | 0 | 1 | 0 | 0 | 1 |
| Mcdermott, Thomas | FUJITSU | Fujitsu | 1 | 1 | 1 | 1 | 4 |
| McDonough, John | NEC Corporation | NEC America | 0 | 1 | 1 | 1 | 3 |
| McNarney, Martin | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 0 | 1 | 2 |
| Mei, Richard | CommScope, Inc. | CommScope, Inc. | 0 | 1 | 1 | 0 | 2 |
| Meier, Wolfgang | Emerson Network Power | Emerson Network Power | 0 | 1 | 1 | 1 | 3 |
| Mellitz, Richard | Intel Corporation | Intel Corporation | 1 | 1 | 1 | 1 | 4 |
| Meyer, Jeffrey | Centellax | Centellax | 1 | 1 | 1 | 1 | 4 |
| Moldovansky, Anatoly | Rockwell Automation | Rockwell Automation | 0 | 0 | 1 | 0 | 1 |
| Montojo, Juan | Qualcomm Incorporated | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Montreuil, Leo | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Mooney, Paul | | Spirent Communications | 1 | 1 | 1 | 1 | 4 |

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|--------------------|-----------------------------------|-----------------------------------|-----|-----|-----|-----|--------|
| Moore, Charles | Avago Technologies | Avago Technologies | 1 | 1 | 1 | 1 | 4 |
| Moorwood, Andy | Infinera Corporation | Infinera Corporation | 1 | 1 | 1 | 1 | 4 |
| Muth, Karlheinz | Texas Instruments Incorporated | Texas Instruments Incorporated | 0 | 1 | 1 | 0 | 2 |
| Nakamoto, Edward | Spirent Communications | Spirent Communications | 1 | 1 | 1 | 1 | 4 |
| Neveux, Paul | | Superior Essex | 0 | 1 | 1 | 0 | 2 |
| Nielsen, Allan | TE Connectivity | TE Connectivity | 1 | 1 | 1 | 1 | 4 |
| Nishihara, Susumu | Nippon Telegraph and Telephone | NTT | 1 | 1 | 1 | 1 | 4 |
| Noll, Kevin | Time Warner Cable Inc. | Time Warner Cable Inc. | 1 | 1 | 1 | 1 | 4 |
| Nordin, Ronald | Panduit Corp. | Panduit Corp. | 0 | 1 | 1 | 1 | 3 |
| Nouri, Ahmad | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Nowell, Mark | Cisco Systems, Inc. | Cisco Systems, Inc. | 0 | 1 | 1 | 1 | 3 |
| Ofelt, David | Juniper Networks, Inc. | Juniper Networks, Inc. | 1 | 1 | 1 | 0 | 3 |
| Ogura, Ichiro | | PETRA | 1 | 1 | 1 | 1 | 4 |
| Palkert, Tom | EIC | Xilinx-Luxtera-Molex | 1 | 1 | 1 | 1 | 4 |
| Pardo, Carlos | Knowledge Development for POF SL | KDPOF | 1 | 1 | 1 | 0 | 3 |
| Parnaby, Gavin | Solarflare Communications | Marvell Semiconductor, Inc. | 0 | 1 | 1 | 1 | 3 |
| Patel, Pravin | | IBM | 0 | 1 | 1 | 1 | 3 |
| Pepper, Gerald | | Ixia | 1 | 1 | 1 | 0 | 3 |
| Peters, Michael | Sumitomo Electric Industries, LTD | Sumitomo Electric Industries, LTD | 1 | 1 | 1 | 0 | 3 |
| Petrilla, John | Avago Technologies | Avago Technologies | 0 | 1 | 1 | 1 | 3 |
| Pietsch, Christian | Qualcomm Incorporated | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Pimpinella, Rick | Panduit Corp. | Panduit Corp. | 1 | 1 | 0 | 0 | 2 |
| Powell, William | ALCATEL-LUCENT | ALCATEL-LUCENT | 1 | 1 | 1 | 1 | 4 |
| Prodan, Richard | | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Rabinovich, Rick | | ALCATEL-LUCENT | 1 | 1 | 1 | 1 | 4 |
| Rahman, Saifur | Comcast | Comcast | 1 | 1 | 1 | 1 | 4 |
| Rahman, Syed | | Huawei R&D USA | 0 | 1 | 1 | 1 | 3 |
| Rajkotia, Purva | Qualcomm Incorporated | Qualcomm Incorporated | 1 | 1 | 1 | 1 | 4 |

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|--------------------------|------------------------------------|-------------------------------------|-----|-----|-----|-----|--------|
| Remein, Duane | FiberHome Technologies Group | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Ressl, Michael | Hitachi, Ltd. | Hitachi Cable America Inc. | 0 | 0 | 0 | 1 | 1 |
| Rimboim, Poldi (Pavlick) | Microsemi Corporation | Microsemi Corporation | 0 | 1 | 1 | 1 | 3 |
| Ruotolo, Frank | Legrand Ortronics | Legrand | 1 | 1 | 1 | 0 | 3 |
| Saitoh, Agi | | KDDI Corporation | 1 | 1 | 1 | 1 | 4 |
| Sayre, Edward | | North East Systems Associates, Inc. | 1 | 1 | 1 | 1 | 4 |
| Schmitt, Matthew | Cable Television Laboratories Inc. | Cable Television Laboratories Inc. | 1 | 1 | 1 | 1 | 4 |
| Shanbhag, Megha | Tyco Electronics Corporation | TE Connectivity | 0 | 0 | 1 | 1 | 2 |
| Shellhammer, Stephen | Qualcomm Incorporated | Qualcomm Incorporated | 0 | 1 | 1 | 0 | 2 |
| Shen, Bazhong | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Shrikhande, Kapil | Force 10 Networks, Inc. | Dell | 1 | 1 | 1 | 0 | 3 |
| Sommers, Scott | Molex Incorporated | Molex Incorporated | 1 | 1 | 1 | 0 | 3 |
| Sparrowhawk, Bryan | Leviton Manufacturing Co. | Leviton Manufacturing Co. | 1 | 1 | 1 | 1 | 4 |
| Staniec, Thomas | Cohere Networks | Cohere Networks | 1 | 1 | 1 | 1 | 4 |
| Stassar, Peter | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 0 | 3 |
| Stevens, Daniel | Fujitsu Semiconductor Europe | Fujitsu Semiconductor Europe | 1 | 1 | 1 | 1 | 4 |
| Suzuki, Ken-Ichi | Nippon Telegraph and Telephone | NTT | 1 | 1 | 1 | 1 | 4 |
| Suzuki, Shinji | | Sumitomo Electric Networks, Inc. | 1 | 1 | 1 | 1 | 4 |
| Szeto, William | Xtera Communications | 3C Systems Company | 1 | 1 | 1 | 1 | 4 |
| TAJIMA, AKIO | NEC Corporation | NEC Corporation | 1 | 1 | 1 | 1 | 4 |
| TAKAHARA, TOMOO | | FUJITSU LABORATORIES LIMITED | 0 | 1 | 1 | 1 | 3 |
| Takahata, Kiyoto | Nippon Telegraph and Telephone | NTT | 1 | 1 | 1 | 1 | 4 |
| Tanaka, Keiji | | KDDI | 1 | 1 | 1 | 1 | 4 |
| Tanaka, Toshiki | | FUJITSU LABORATORIES LIMITED | 0 | 1 | 1 | 1 | 3 |
| Tawa, Katsuhisa | Sumitomo Electric Industries, LTD | Sumitomo Electric Industries, LTD | 0 | 1 | 1 | 1 | 3 |
| TAZEBAY, MEHMET | Broadcom Corporation | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Teixeira, Antonio L | Nokia Siemens Networks | Nokia Siemens Networks | 0 | 1 | 1 | 1 | 3 |
| Tellas, Ronald | Panduit Corp. | Panduit Corp. | 0 | 1 | 1 | 0 | 2 |

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|---------------------|---------------------------------|------------------------------------|-----|-----|-----|-----|--------|
| Thompson, Geoffrey | GraCaSI S.A. | GraCaSI S.A. | 1 | 1 | 0 | 1 | 3 |
| Toyoda, Hidehiro | Hitachi, Ltd. | Hitachi, Ltd. | 1 | 1 | 1 | 1 | 4 |
| Tremblay, David | Hewlett-Packard Ltd | Hewlett-Packard Company | 1 | 1 | 1 | 1 | 4 |
| Trowbridge, Stephen | ALCATEL-LUCENT | ALCATEL-LUCENT | 1 | 1 | 1 | 1 | 4 |
| Ulm, John | Motorola Mobility | Motorola Mobility | 0 | 1 | 1 | 1 | 3 |
| Vaden, Sterling A. | Optical Cable Corporation (OCC) | Optical Cable Corporation (OCC) | 1 | 1 | 1 | 1 | 4 |
| Valle, Stefano | STMicroelectronics | STMicroelectronics | 0 | 1 | 1 | 1 | 3 |
| Vanderlaan, Paul | Nexans Canada Inc. | Nexans Canada Inc. | 1 | 1 | 1 | 1 | 4 |
| Varanese, Nicola | | Qualcomm Incorporated | 0 | 1 | 1 | 1 | 3 |
| Vijn, Arien | | AMS-IX B.V. | 1 | 1 | 1 | 1 | 4 |
| VLASOV, YURII | IBM | IBM | 1 | 1 | 1 | 0 | 3 |
| Wagner, Robert | Panduit Corp. | Panduit Corp. | 0 | 1 | 1 | 1 | 3 |
| Wang, Robert | Intel Corporation | Intel Corporation | 1 | 1 | 1 | 1 | 4 |
| Wang, Xiaofeng | PMC-Sierra, Inc. | Qualcomm Incorporated | 1 | 1 | 1 | 1 | 4 |
| WANG, Zhong Feng | | Broadcom Corporation | 0 | 1 | 1 | 1 | 3 |
| Weitzner, Andrew | Marvell Semiconductor, Inc. | Ikanos Communications, Inc. | 0 | 0 | 1 | 1 | 2 |
| Welch, Brian | | Luxtera | 0 | 0 | 1 | 0 | 1 |
| Winkel, Ludwig | Siemens AG | Siemens AG | 1 | 1 | 1 | 1 | 4 |
| Woodruff, Bill | Aquantia | Broadcom Corporation | 1 | 0 | 1 | 1 | 3 |
| wu, guangsheng | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Wu, Peter | Marvell Semiconductor, Inc. | Marvell Semiconductor, Inc. | 0 | 1 | 1 | 1 | 3 |
| Xu, Junyi | | Marvell Semiconductor, Inc. | 0 | 1 | 1 | 1 | 3 |
| Xu, Yu | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Yurko, Garold | TE Connectivity | TE Connectivity | 1 | 1 | 1 | 1 | 4 |
| Zambell, Andrew | FCI USA Inc. | FCI USA Inc. | 1 | 1 | 0 | 1 | 3 |
| Zeng, Li | Huawei Technologies Co. Ltd | Huawei Technologies Co. Ltd | 1 | 1 | 1 | 1 | 4 |
| Zhao, Meng | IEEE | IEEE STAFF | 1 | 0 | 0 | 0 | 1 |
| Zhao, Wenyu | Research Institute of | China Academy of Telecommunication | 1 | 1 | 1 | 1 | 4 |

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|-------------------|-----------------|--------------------|------------|------------|------------|------------|---------------|
| Zimmerman, George | CME Consulting | Aquantia | 0 | 1 | 1 | 1 | 3 |